

Conference Committee

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Topics

Material Science and Engineering:

Composites

Micro / Nano Materials

Metal alloy Materials

Materials Physics and Chemistry

Mechanical and Manufacturing Engineering:

Mechanical and Materials Engineering

Applied Mechanics and Design

Computational Fluid Dynamics

For more topics, please visit:

http://www.icnmm.org/cfp.html

Publication



The registered and presented papers will be published into Materials Science Forum.

Indexed by Ei Compendex, Scopus, Inspec, DOAJ, Web of Science (CPCI), etc.

Submission

Click the following url and direct you to the submission page:

http://confsys.iconf.org/submission/icnmm2021

For any queries, please send email to: icnmm@cbees.net

Speakers



Prof. Daohua Zhang (FInstP, FIET),
Nanyang Technological University, Singapore



Prof. Juin J. Liou (FIEEE), Shenzhen University, China



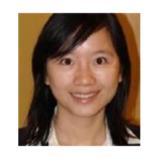
Prof. Xiaoqing Wen (FIEEE), Kyushu Institute of Technology, Japan



Prof. Tayeb Mohammed-Brahim, University of Rennes 1, France



Assoc. Prof. Jun Wu,
Southeast University, China



Prof. Shumin Xiao,
Harbin Institute of Technology, Shenzhen, China



Prof. Byung Seong Bae, Hoseo University, Korea

Important Dates

Submission Due May 20, 2021

Notification Due June 10, 2021

Registration Deadline June 25, 2021





